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DATA SHEET

PART NO.: L514EIR4C-Z-4-A-HB

REV: A/2

PARA LIGHT ENGINEERING:

CUSTOMER'S APPROVAL:

DRAWING NO. : DS-23-10-0062

DATE: 2012-3-31

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Page:1



L514EIR4C-Z-4-A-HB

REV:A/2

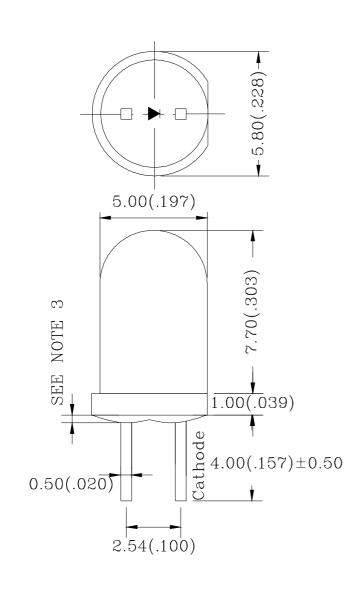
PACKAGE DIMENSIONS

ITEM	MATERIALS
RESIN	Epoxy Resin
LEAD FRAME	Sn Plating iron Alloy

Note:

- 1.All Dimensions are in millimeters.
- 2.Tolerance is ±0.25mm(0.010 ") Unless otherwise specified.
- 3. Protruded resin under flange

is 1.5mm(0.059 ") max.



DRAWING NO. : DS-23-10-0062

DATE : 2012-3-31

Page: 2

L514EIR4C-Z-4-A-HB

REV:A/2

FEATURES

PARA

ight

- * High-brightness
- * High reliability
- * Low-voltage characteristics
- * Narrow view angle
- * Pb FREE Products
- * RoHS Compliant

CHIP MATERIALS

- * Dice Material : GaAlAs/GaAs
- * Lens Color : WATER CLEAR

ABSOLUTE MAXIMUM RATING : (Ta = 25 BC)

SYMBOL	PARAMETER	MAX	UNIT
PD	Power Dissipation	240	mW
Vr	Reverse Voltage	5	V
IF	Forward Current	120	mA
IFP	Peak forward current (0.1 ms Pulse Width, 10% Duty Cycle)	500	mA
Topr	Operating Temperature Range	-25BC to 85BC	
Tstg	Storage Temperature Range	-25BC to 85BC	

ELECTRO-OPTICAL CHARACTERISTICS : (Ta = 25 BC)

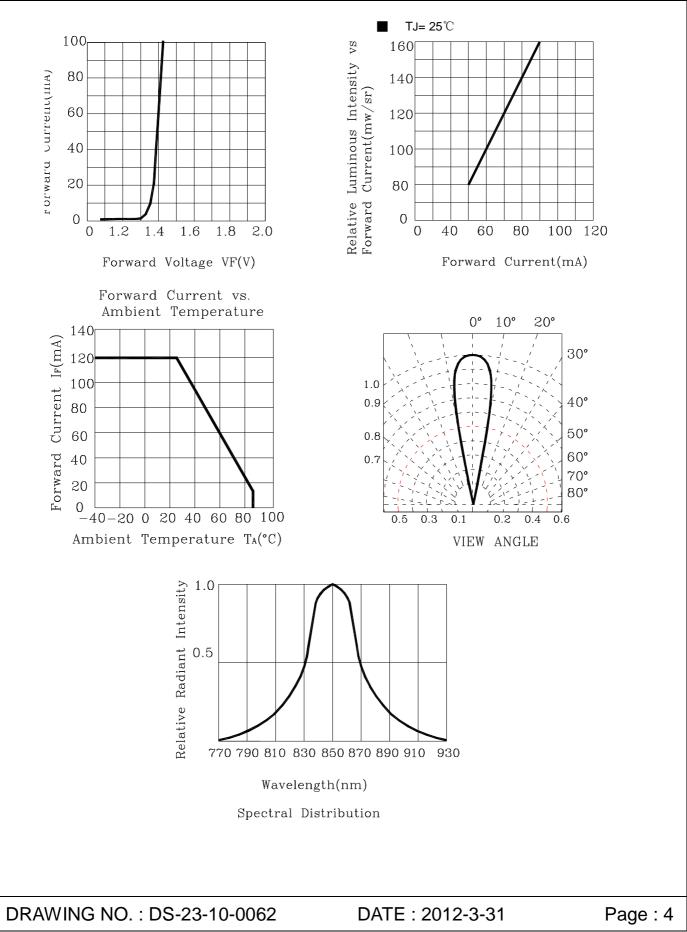
SYMBOL	PARAMETER	TEST	MIN.	TYP.	MAX.	UNIT
STIVIDUL		CONDITION				
VF	Forward Voltage	IF = 50mA		1.4	1.8	V
		IF = 70mA		1.5	1.8	V
IR	Reverse Current	VR = 5V			10	mA
lp	Peak Emission Wavelength	IF = 50mA		850		nm
201/2	Half Intensity Angle	IF = 50mA		20		deg
le	Radiant Intensity	IF = 50mA		80		mw/sr
		IF = 70mA		120		

DATE : 2012-3-31



L514EIR4C-Z-4-A-HB

REV:A/2





L514EIR4C-Z-4-A-HB

F

REV:A/2

Label Explanation

PART	NO.	:L51	4EIR4C-Z-4	-A-HB
LOT	NO.	•		INSPECTED
BIN		•		
Q'	ΤY	•	PCS	
N. W		•	g	

PART NO. : L514EIR4C-Z-4-A-HB Refer to page 13

LOT NO.: E L L 4 7 0009

ABCDE

A---E: For Serial number

- B---L: Local F: Foreign
- C---L: LAMP
- D----Year
- E---Month
- F---Serial number

DRAWING NO. : DS-23-10-0062

DATE : 2012-3-31

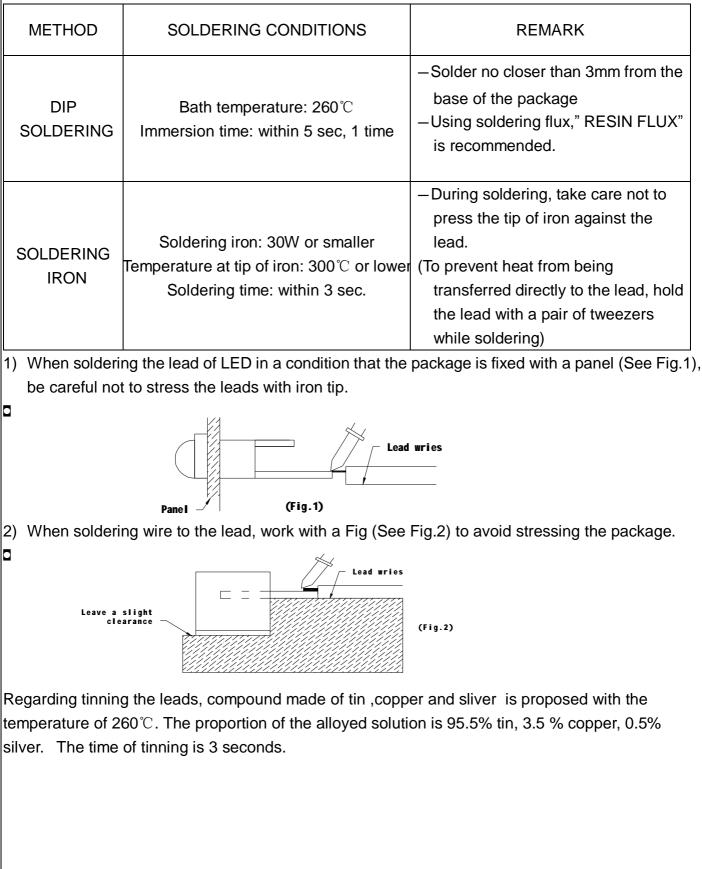
Page: 5



L514EIR4C-Z-4-A-HB

REV:A/2

-SOLDERING



DATE : 2012-3-31



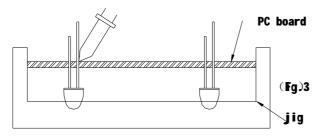
0

5.0 mm INFRARED EMITTING DIODE

L514EIR4C-Z-4-A-HB

REV:A/2

3) Similarly, when a jig is used to solder the LED to PC board, take care as much as possible to avoid stressing the leads (See Fig.3).



- Repositioning after soldering should be avoided as much as possible. If inevitable: select a best-suited method that assures the least stress to the LED.
- Lead cutting after soldering should be performed only after the LED temperature has returned to normal temperature.

-STORAGE

- 1) The LEDs should be stored at 30° C or less and 70% RH or less after being shipped from PARA and the storage life limit is 1 year .
- 2) PARA LED lead frames are comprised of a tin plated iron alloy. The surface may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LEDs to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.
- 3) Please avoid rapid changes in ambient temperature, especially, in high humidity environments where condensation can occur.

PARA ight

5.0 mm INFRARED EMITTING DIODE

L514EIR4C-Z-4-A-HB

REV:A/2

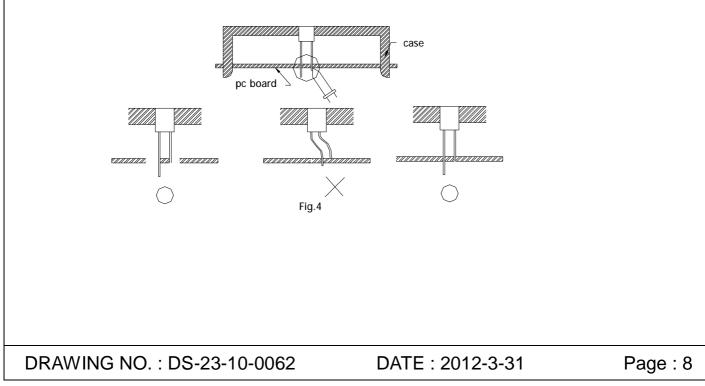
-STATIC ELECTRICITY

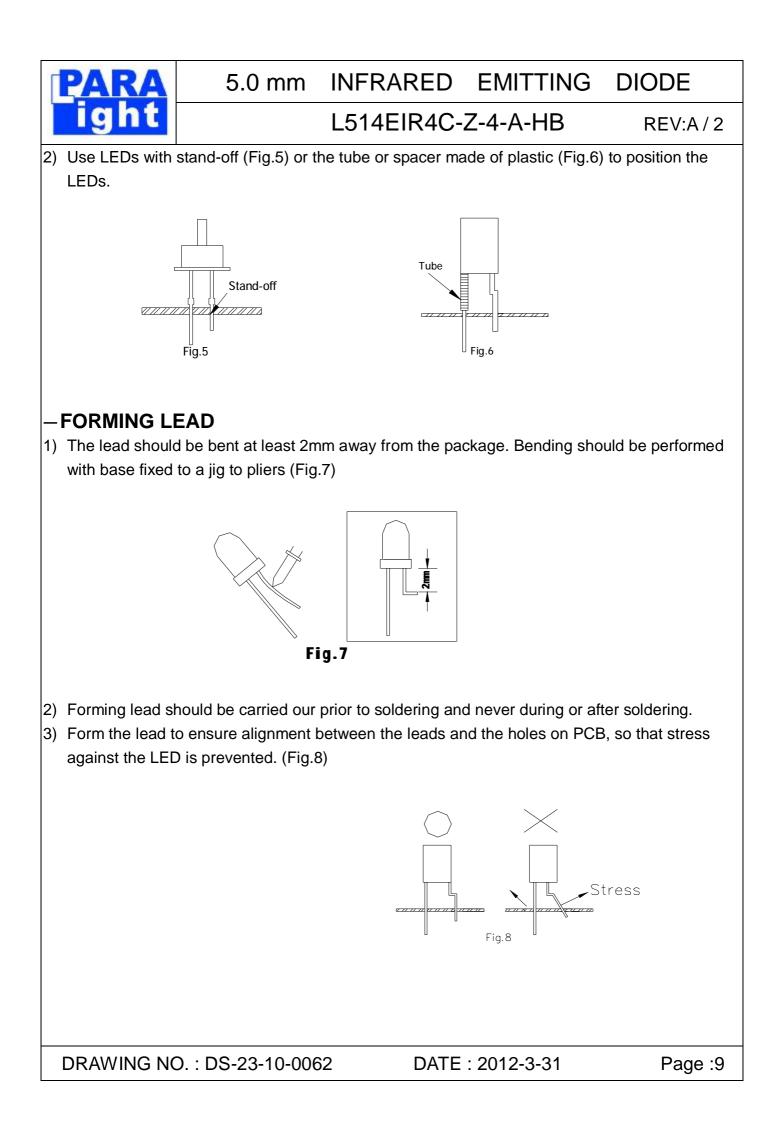
- Static electricity or surge voltage damages the LEDs.
 It is recommended that a wrist band and an anti-electrostatic glove be used when handling the LEDs.
- 2) All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the LED mounting equipment.
- 3) When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity. To find static-damaged LEDs, perform a light-on test or a VF test at a lower current (below 1mA is recommended).
- 4) Damaged LEDs will show some unusual characteristics such as the leakage current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.

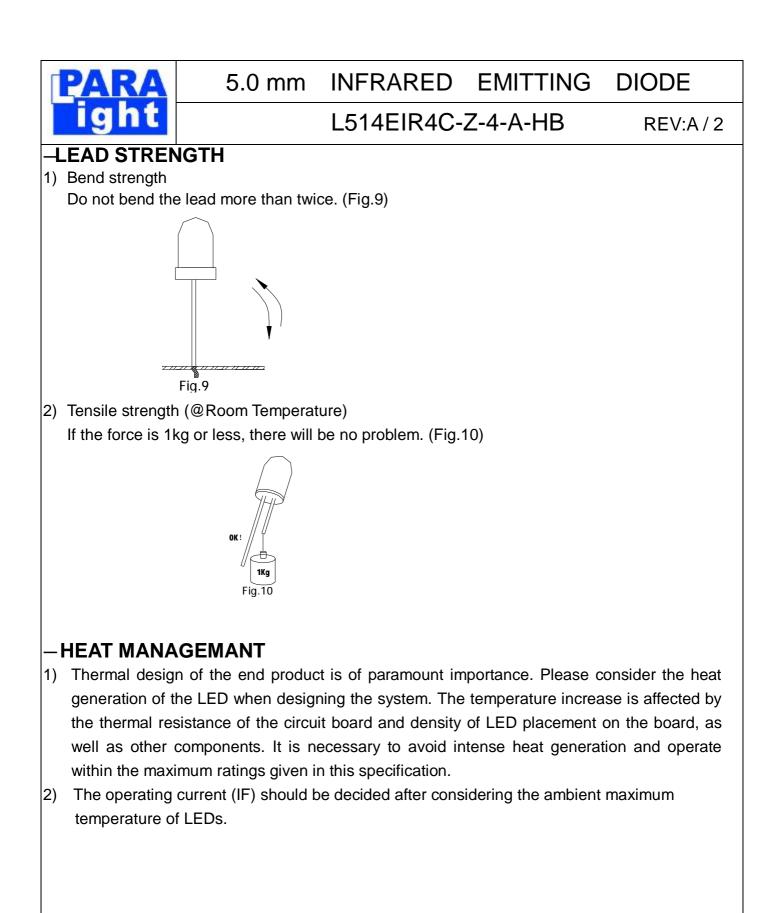
Criteria : (VF>2.0V at IF=0.5mA)

-LED MOUNTING METHOD

1) When mounting the LED to a housing, as shown on Fig.4, ensure that the mounting holes on the PC board match the pitch of the leads correctly. Tolerance of dimensions of the respective components including the LEDs should be taken into account especially when designing the housing, PC board, etc. to prevent pitch misalignment between the leads and holes on PCB, the diameter of the holes should be slightly larger than the size of the lead. Alternatively, the shape of the holes could be made oval. (See Fig.4)







DRAWING NO. : DS-23-10-0062

DATE : 2012-3-31

Page :10



INFRARED EMITTING 5.0 mm DIODE

NOTE: Influences of ultrasonic cleaning of the LED

resin body differ depending on factors such as the oscillator output, size of the PC board

and the way in which the LED is mounted.

performed by confirming an ultrasonic

Therefore, ultrasonic cleaning should only be

L514EIR4C-Z-4-A-HB

REV:A/2

-CHEMICAL RESISTANCE

- 1) Avoid exposure to chemicals as it may attack the LED surface and cause discoloration.
- 2) When washing is required, refer to the following table for the proper chemical to be used.
 - (Immersion time: within 3 minutes at room temperature.)

SOLVENT	ADAPTABILITY
Freon TE	\odot
Chlorothene	\times
Isopropyl Alcohol	\odot
Thinner	\times
Acetone	\times
Trichloroethylene	\times

⊙--Usable \times --Do not use.

-OTHER CONSIDERTIONS

1) Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum

cleaning trial run.

- rating when using the LEDs with matrix drive.
- 2) The LEDs described in this data sheet are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult PARA's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, spacecraft, automobiles, traffic control equipment etc).
- 3) The formal specifications must be exchanged and signed by both parties before large volume purchase begins.



L514EIR4C-Z-4-A-HB

REV:A/2

Bin Code List					
Luminous Inter	Luminous Intensity(IE), Unit: mw/sr @70mA				
Bin Code	Min Max				
Z1	74	82			
Z2	82	97			
Z3	97	112			
Z4	112	127			
Z5	127	142			
Z6	142	160			
Z7	160	180			
Toleran	Tolerance of each bin are±15%				
Forward V	oltage (VF), Uni	t:v@70mA			
Bin Code	Min	Max			
A0	1.3	1.4			
A	1.4	1.5			
В	1.5	1.6			
С	1.6	1.7			
D	1.7	1.8			
Tolerance of each bin are±0.1Volt					

DRAWING NO. : DS-23-10-0062

DATE : 2012-3-31

Page :12



L514EIR4C-Z-4-A-HB

REV:A/2

